

### **Features**

- Select models are compliant with AEC-Q200 Rev-C Stress Test Qualification for Passive Components in Automotive Applications (see chart below)
- RoHS compliant\*
- ESD protection >25 kV
- Low capacitance <0.05 pF
- Low leakage current <5 nA

### **Applications**

- HDMI 1.4
- Digital Visual Interface (DVI)
- USB 3.0 / USB OTG
- Memory protection
- SIM card ports
- Automotive

## ChipGuard® MLU Series - ESD Protectors

#### **General Information**

The ChipGuard® MLU Series has been specifically designed to protect sensitive electronic components from electrostatic discharge damage. The MLU family has been designed to protect equipment to IEC61000-4-2, Level 4 (±8 kV Contact / ±15 kV Air Discharge) ESD specifications targeted for high speed USB 3.0/USB OTG, HDMI 1.4, DVI or IEEE1394 applications.

The ChipGuard® MLU Series has been manufactured to provide low 0.05 pF capacitance and leakage currents less than 5 nA with excellent clamp qualities, making the family almost transparent under normal working conditions.

### **AEC Approved Models**

Model	AEC-Q200
CG0402MLU-05G	✓ Yes
CG0402MLU-12G	✓ Yes
CG0402MLU-24G	✓ Yes
CG0603MLU-05E	✓ Yes
CG0603MLU-24E	✓ Yes

### **Device Symbol**



### Electrical Characteristics @ 25 °C (unless otherwise noted)

		CG0402MLU / CG0603MLU (Note 3)				
Parameter	Symbol	3.3x	05x	12x	24x	Unit
Typical Continuous Operating Voltage	V <sub>DC</sub>	3.3	5	12	24	V
Typical Clamping Voltage (Note 1)	V <sub>C</sub>	25			V	
Maximum Capacitance @ 1 VRMS 1 MHz	CO	0.05			pF	
Maximum Leakage Current @ Max. VDC	IL	5			nA	
Typical Trigger Voltage (Note 2)	V <sub>T</sub>	250			V	
Maximum ResponseTime	R <sub>T</sub>	1		ns		
ESD Protection: Per IEC 61000-4-2 Min. Contact Discharge (>1000 Reps) Min. Air Discharge (>1000 Reps)		±8 ±15		kV kV		
Operating Temperature	T <sub>OPR</sub>	-40 to +125		°C		
Storage Temperature	TSTG	-55 to +150		°C		

Notes: 1. Per IEC 61000-4-2, Level 4 8 kV Contact Discharge. Measurement 30 ns after initiation of pulse.

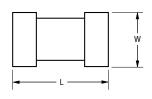
- 2. Per IEC 61000-4-2, Level 4 8 kV Contact Discharge. Measurement at maximum pulse voltage.
- 3. Part number suffix "x" can be E for 0603 size or G for 0402 size to indicate tape & reel quantity.

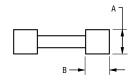
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### BOURNS

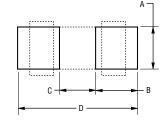
**Recommended Pad Layout** 

### **Product Dimensions**





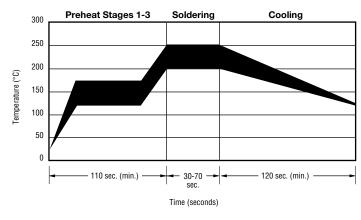
DIMENSIONS:  $\frac{MM}{(INCHES)}$ 



Dimension	CG0402 Series	CG0603 Series
L	$\frac{1.00 \pm 0.15}{(0.04 \pm 0.006)}$	$\frac{1.60 \pm 0.20}{(0.064 \pm 0.008)}$
W	$\frac{0.50 \pm 0.10}{(0.02 \pm 0.004)}$	$\frac{0.80 \pm 0.20}{(0.032 \pm 0.008)}$
А	$\frac{0.36 \pm 0.05}{(0.014 \pm 0.002)}$	$\frac{0.45 \pm 0.10}{(0.018 \pm 0.004)}$
В	$\frac{0.25 \pm 0.15}{(0.10 \pm 0.006)}$	$\frac{0.30 \pm 0.20}{(0.012 \pm 0.008)}$

Dim.	CG0402 Series	CG0603 Series
Α	<u>0.51</u> (0.020)	0.76 (0.030)
В	0.61 (0.024)	1.02 (0.040)
С	0.51 (0.020)	0.50 (0.020)
D	1.70 (0.067)	<u>2.54</u> (0.100)

#### **Solder Reflow Recommendations**



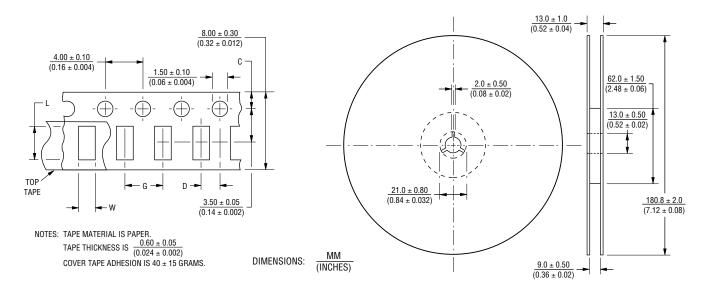
Α	Stage 1 Preheat	Ambient to Preheating Temperature	30 s to 60 s
В	Stage 2 Preheat	140 °C to 160 °C	60 s to 120 s
С	Stage 3 Preheat	Preheat to 200 °C	20 s to 40 s
D	Main Heating	200 °C	60 s to 70 s
		210 °C	55 s to 65 s
		220 °C	50 s to 60 s
		230 °C	40 s to 50 s
		240 °C	30 s to 40 s
ш	Cooling	200 °C to 100 °C	1 °C/s to 4 °C/s

- This product can be damaged by rapid heating, cooling or localized heating.
- Heat shocks should be avoided. Preheating and gradual cooling recommended.
- Excessive solder can damage the device. Print solder thickness of 150 to 200 um recommended.
- Solder gun tip temperature should be kept below 280 °C and should not touch the device directly. Contact should be less than 3 seconds.
   A solder gun under 30 watts is recommended.

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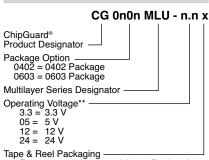
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### **Packaging Dimensions**



Dimension	CG0402 Series	CG0603 Series
С	$\frac{1.75 \pm 0.05}{(0.04 \pm 0.002)}$	$\frac{1.75 \pm 0.10}{(0.04 \pm 0.004)}$
D	$\frac{2.00 \pm 0.02}{(0.08 \pm 0.0008)}$	$\frac{2.00 \pm 0.05}{(0.08 \pm 0.002)}$
L	$\frac{1.12 \pm 0.03}{(0.045 \pm 0.0012)}$	$\frac{1.80 \pm 0.20}{(0.072 \pm 0.008)}$
W	$\frac{0.62 \pm 0.03}{(0.025 \pm 0.0012)}$	$\frac{0.90 \pm 0.20}{(0.036 \pm 0.008)}$
G	$\frac{2.0 \pm 0.05}{(0.08 \pm 0.002)}$	$\frac{4.0 \pm 0.05}{(0.16 \pm 0.002)}$

### **How to Order**



Tape & Reel Packaging

E = 5,000 pcs. per reel (0603 Package)

G = 10,000 pcs. per reel (0402 Package)

REV. J 09/12

## **BOURNS**®

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Specifications are subject to change without notice. Customers should verify actual device performance in their specific applications.

<sup>\*\*</sup> Only models lower than 10 volts require decimal point.